wieland

Wieland-K55

CuNi3Si1Mg | High copper alloy

Material designation		
EN	_	
UNS	C70250	

Chemical composition*		
balance		
3 %		
0.65 %		
0.15 %		
< 0.05 %		

* Reference values in % by weight

Physical properties*		
electrical conductivity in precipitation hardened condition	MS/m %IACS	29 50
Thermal conductivity	W/(m·K)	190
Thermal expansion coefficient (0–300 °C)	10-6/K	17.6
Density	g/cm³	8.82
Modulus of elasticity	GPa	130

* Reference values at room temperature

Corrosion resistance

Wieland-K55 has good corrosion resistance in natural atmosphere. It is insensitive to stress corrosion cracking.

Material properties and typical applications

Wieland K55 is a high-performance alloy with low contents of nickel and silicon. It is precipitation hardened and exhibits high strength, good electrical conductivity and good bending properties. Moreover, it possesses excellent resistance to stress relaxation at elevated temperatures of up to 200 °C.

The material is lead free according to RoHS and ELV.

Types of delivery

The BU Extruded Products supplies bars, wire, sections and tubes. Please get in touch with your contact person regarding the available delivery forms, dimensions and tempers.

Fabrication properties					
Forming*		Surface treatment			
Machinability (CuZn39Pb3 = 100 %)	25 %	Polishing mechanical	good		
Capacity for being cold worked	good	elektrolytic Electroplating	good good		
Capacity for being hot worked	poor				

Joining	
Resistance welding	fair
(butt weld)	
Inert gas shielded arc	excellent
welding	
Gas welding	fair
Hard soldering	good
Soft soldering	good

Heat treatment	
Melting range	1,040–1,085 °C
Hot working	800–950 °C
Soft annealing	600–700 °C 1–3 h
Thermal stress relieving	-

Product standards

nicht genormt

Trademarks

OWICONNEC.

WITRONIC°

Further information is provided in our brochures on WITRONIC and WI-CONNEC.

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